Complementary Darlington Power Transistor

DPAK For Surface Mount Applications

Designed for general purpose amplifier and low speed switching applications.

Features

- Monolithic Construction With Built-in Base-Emitter Shunt Resistors
- High DC Current Gain: $h_{FE} = 2500$ (Typ) @ $I_C = 4.0$ Adc
- Epoxy Meets UL 94 V-0 @ 0.125 in.
- ESD Ratings:
 - Human Body Model, 3B > 8000 V
 - Machine Model, C > 400 V
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These are Pb–Free Devices*

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-----------------------------------|----------------|-----------|
| Collector-Emitter Voltage | V _{CEO} | 120 | Vdc |
| Collector-Base Voltage | V _{CB} | 120 | Vdc |
| Emitter-Base Voltage | V_{EB} | 5 | Vdc |
| Collector Current Continuous Peak | I _C | 8 16 | Adc |
| Base Current | Ι _Β | 120 | mAdc |
| Total Power Dissipation @ T _C = 25°C Derate above 25°C | P _D | 20 0.16 | W/∘C |
| Total Power Dissipation* @ T _A = 25°C Derate above 25°C | P _D | 1.75 0.014 | W ₩/°C |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | -65 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|------|------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 6.25 | °C/W |
| Thermal Resistance, Junction-to-Ambient (Note 1) | R_{\thetaJA} | 71.4 | °C/W |

1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

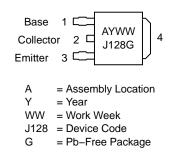
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SILICON POWER TRANSISTOR 8 AMPERES 120 VOLTS, 20 WATTS



DPAK CASE 369C STYLE 1

MARKING DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|-------------------|-----------------------|
| MJD128T4G | DPAK (Pb–Free) | 2,500/Tape & Reel |
| NJVMJD128T4G | DPAK (Pb–Free) | 2,500/Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

| Symbol | Min | Max | Unit |
|-----------------------|--|--|---|
| | | | |
| V _{CEO(sus)} | 120 | _ | Vdc |
| I _{CEO} | _ | 5 | mA |
| I _{CBO} | _ | 10 | μAdc |
| I _{EBO} | _ | 2 | mAdc |
| | | | |
| h _{FE} | 1000 100 | 12,000 | _ |
| V _{CE(sat)} | - | 2 4 | Vdc |
| V _{BE(sat)} | _ | 4.5 | Vdc |
| V _{BE(on)} | - | 2.8 | Vdc |
| | | · | |
| h _{fe} | 4 | _ | MHz |
| C _{ob} | _ | 300 | pF |
| h _{fe} | 300 | _ | - |
| | VCEO(sus) ICEO ICBO ICBO IEBO VCE(sat) VBE(sat) VBE(on) Ihfe Cob | VCEO(sus) 120 ICEO - ICBO - ICBO - IEBO - VCE(sat) - VBE(sat) - VBE(on) - Ihfe 4 Cob - hfe - | V _{CEO(sus)} 120 - I _{CEO} - 5 I _{CBO} - 10 I _{EBO} - 2 h _{FE} 1000 100 12,000 - VCE(sat) - 2 4 VBE(sat) - 4.5 VBE(on) - 2.8 Ih _{fe} 4 - Observation - 300 |

2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

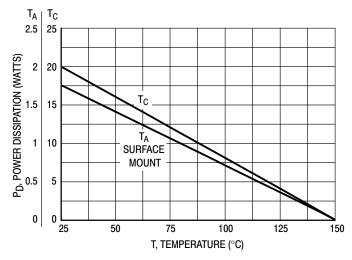
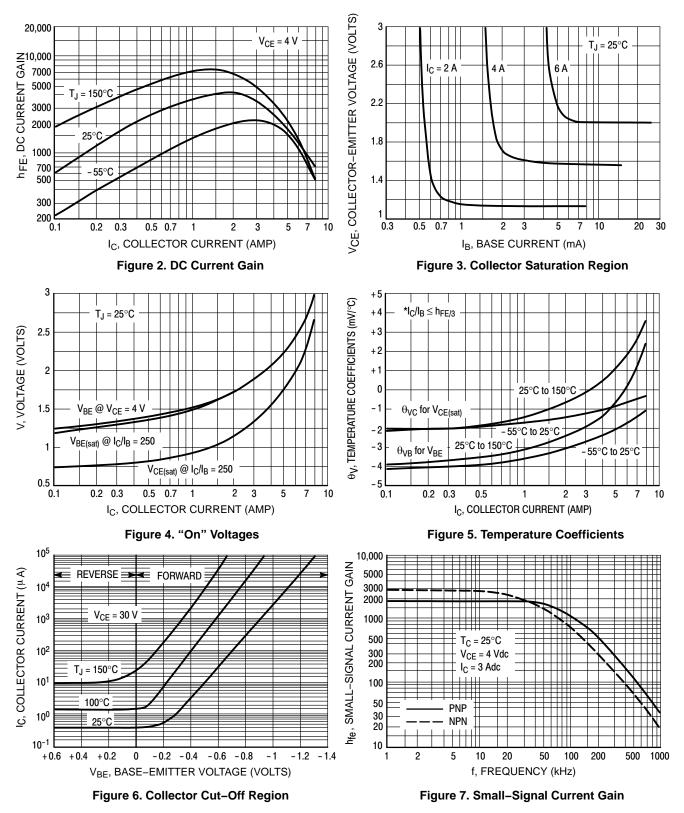


Figure 1. Power Derating

TYPICAL ELECTRICAL CHARACTERISTICS



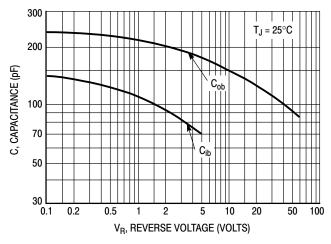


Figure 8. Capacitance

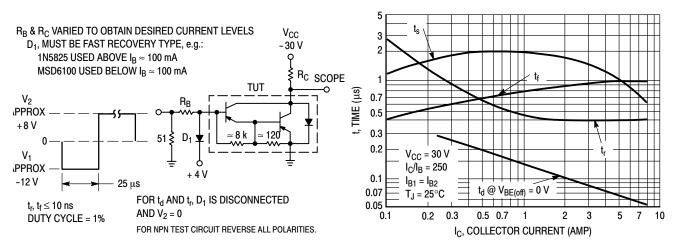




Figure 10. Switching Times

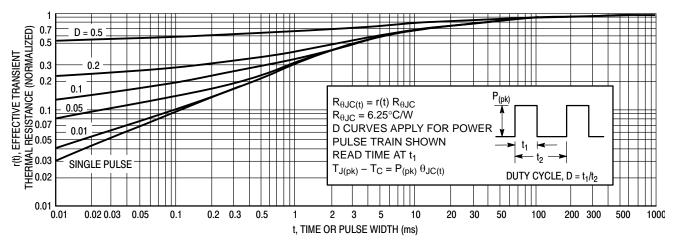


Figure 11. Thermal Response

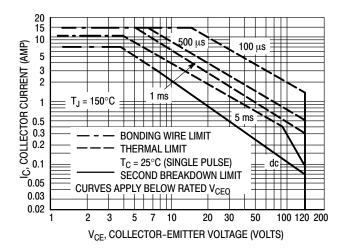


Figure 12. Maximum Forward Bias Safe Operating REA

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 12 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} < 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 11. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

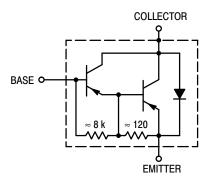
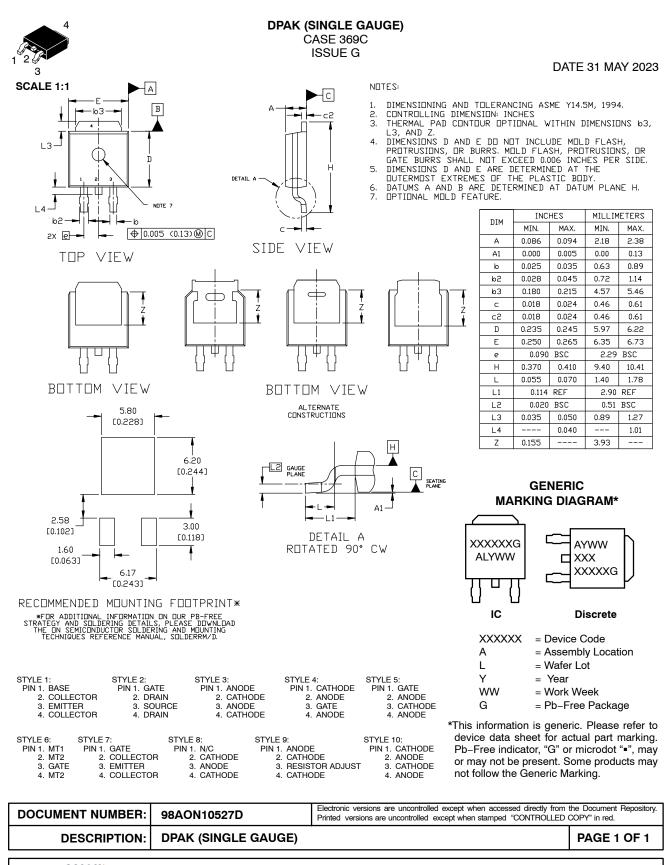


Figure 13. Darlington Schematic

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